

**ON Semiconductor®** 

# FDP8030L/FDB8030L

## N-Channel Logic Level PowerTrench<sup>®</sup> MOSFET

#### **General Description**

This N-Channel Logic level MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers.

These MOSFETS feature faster switching and lower gate charge than other MOSFETS with comparable  $R_{\text{DS}(\text{on})}$  specifications.

The result is a MOSFET that is easy and safer to drive (even at very high frequencies), and DC/DC power supply designs with higher overall efficiency.

#### Features

- 80 A, 30 V.  $R_{DS(ON)} = 0.0035 \ \Omega \ @ \ V_{GS} = 10 \ V$  $R_{DS(ON)} = 0.0045 \ \Omega \ @ \ V_{GS} = 4.5 \ V$
- Critical DC electrical parameters specified at elevated temperature
- Rugged internal source-drain diode can eliminate the need for an external Zener diode transient suppressor
- High performance trench technology for extremely low R<sub>DS(ON)</sub>

• 175°C maximum junction temperature rating

G TO-220 S TO-220 FDP Series FDP Series

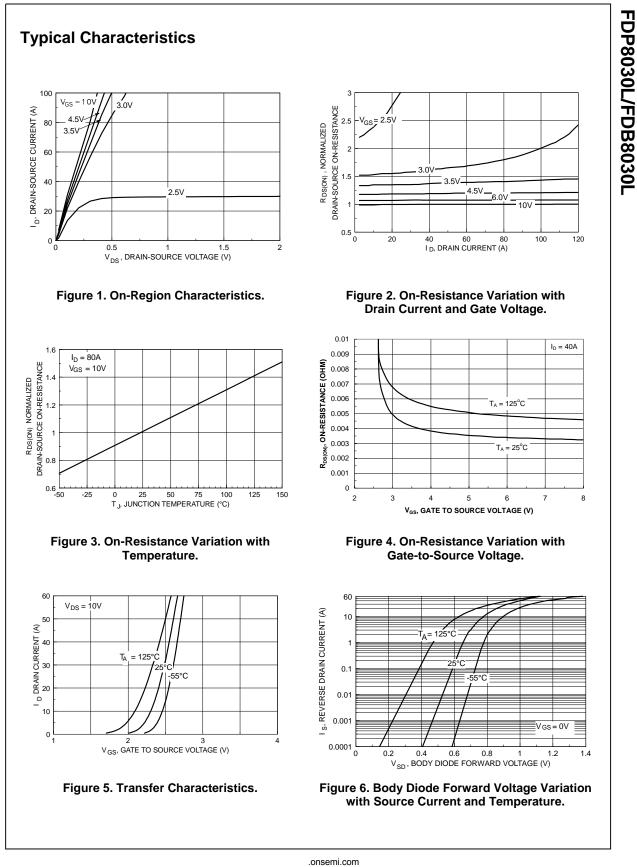
### Absolute Maximum Ratings TA=25°C unless otherwise noted

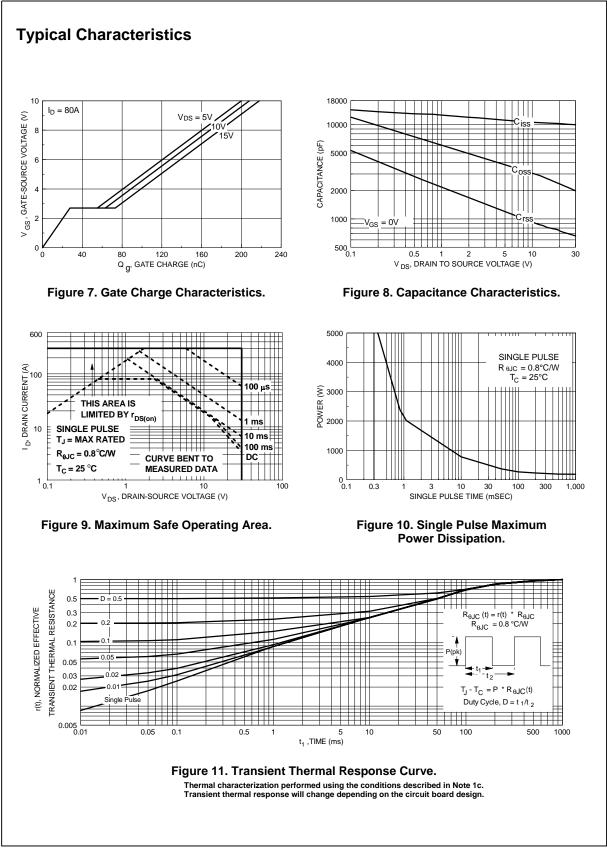
Symbol	Parameter	Ratings	Units	
V <sub>DSS</sub>	Drain-Source Voltage	30	V	
V <sub>GSS</sub>	Gate-Source Voltage	±20	V	
I <sub>D</sub>	Drain Current – Continuous (Note 1)	80	A	
	– Pulsed (Note 1)	300		
PD	Total Power Dissipation @ $T_C = 25^{\circ}C$	187	W	
	Derate above 25°C	1.25	W°C	
$T_{J}, T_{STG}$	Operating and Storage Junction Temperature Range	-65 to +175	°C	
TL	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds	275	°C	
Therma	I Characteristics			
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction-to-Case	0.8	°C/W	
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	62.5	°C/W	

©2012 Semiconductor Components Industries, LLC. October-2017, Rev. 3

Symbol	Parameter	Test Conditions	Min	Тур	Мах	Units
Drain-So	Durce Avalanche Ratings (Note 1	)	1			
W <sub>DSS</sub>	Single Pulse Drain-Source	$V_{DD} = 20 \text{ V}, \qquad I_D = 80 \text{ A}$			1500	mJ
1	Avalanche Energy Maximum Drain-Source Avalanche				80	A
AR	Current				80	A
Off Char	racteristics					
BV <sub>DSS</sub>	Drain–Source Breakdown Voltage	$V_{GS} = 0 V, I_{D} = 250 \mu A$	30			V
<u>ΔBV<sub>DSS</sub></u> ΔT <sub>J</sub>	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$ , Referenced to $25^{\circ}\text{C}$		23		mV/°C
DSS	Zero Gate Voltage Drain Current	$V_{DS} = 24 \text{ V},  V_{GS} = 0 \text{ V}$			10	μA
GSSF	Gate–Body Leakage, Forward	$V_{GS} = 20 \text{ V}, \qquad V_{DS} = 0 \text{ V}$			100	nA
GSSR	Gate-Body Leakage, Reverse	$V_{GS} = -20 V$ $V_{DS} = 0 V$			-100	nA
On Char	acteristics (Note 2)					
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	1	1.5	2	V
<u>ΔVgs(th)</u> ΔTj	Gate Threshold Voltage Temperature Coefficient	$I_D$ = 250 µA, Referenced to 25°C		-5		mV/°C
R <sub>DS(on)</sub>	Static Drain–Source	$V_{GS} = 10 \text{ V}, \qquad I_D = 80 \text{ A}$		3.1	3.5	mΩ
	On–Resistance	$T_{J}=125^{\circ}C$ V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 70 A		4.0 3.6	5.6 4.5	
D(on)	On–State Drain Current	$V_{GS} = 4.5 V$ , $I_D = 70 R$ $V_{GS} = 10 V$ , $V_{DS} = 10 V$	60	5.0	4.5	A
g <sub>FS</sub>	Forward Transconductance	$V_{DS} = 10 V$ , $V_{DS} = 10 V$ $V_{DS} = 10 V$ , $I_{D} = 80 A$	00	170		s
Dynamic C <sub>iss</sub>	c Characteristics	$V_{DS} = 15 V$ , $V_{GS} = 0 V$ ,		10500	I	pF
Coss	Output Capacitance	$v_{\rm DS} = 15$ V, $v_{\rm GS} = 0$ V, f = 1.0 MHz		2700		pF
	Reverse Transfer Capacitance			1650		pF
				1000		Pi
D(on)	ng Characteristics (Note 2) Turn–On Delay Time			20	35	ns
	Turn–On Rise Time			185	225	ns
D (off)	Turn–Off Delay Time			160	200	ns
- () f	Turn–Off Fall Time			200	240	ns
Q <sub>g</sub>	Total Gate Charge	$V_{DS} = 15 V,$ $I_{D} = 80 A, V_{GS} = 5 V$		120	170	nC
Q <sub>gs</sub>	Gate-Source Charge			27		nC
Q <sub>gd</sub>	Gate–Drain Charge			48		nC
Drain-S	ource Diode Characteristics a	nd Maximum Ratings				
ls	Maximum Continuous Drain–Source				80	А
Ism	Maximum Pulsed Drain-Source Diode				300	А
V <sub>SD</sub>	Drain–Source Diode Forward Voltage			1	1.3	V

FDP8030L/FDB8030L





FDP8030L/FDB8030L

.onsemi.com

ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent-Marking.pdf</u>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor haves, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such uninten

#### PUBLICATION ORDERING INFORMATION

#### LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800–282–9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910

Japan Customer Focus Center Phone: 81–3–5817–1050 ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative